

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

Title of Invention	[LOW TEMPERATURE POLYSILICON THIN FILM TRANSISTOR AND METHOD OF FORMING POLYSILICON LAYER OF SAME]				
Application Number :					
Date :					
First Named Applicant:	Mr. Chia-Tien Peng				
Confirmation Number:					
Attorney Docket Number:	10957-US-PA				
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<table border="1"><tr><td>Submitted By:</td><td>Elec. Sign.</td></tr><tr><td>Dr. Belinda Lee Registered Number: 46863</td><td>/Belinda Lee/</td></tr></table>		Submitted By:	Elec. Sign.	Dr. Belinda Lee Registered Number: 46863	/Belinda Lee/
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Documents being submitted:	Files
us-request	10957-usrequ.xml us-request.dtd us-request.xsl
us-assignment	10957-usassn.xml us-assignment.xsl us-assignment.dtd 10957assignment1.tif 10957assignment2.tif
us-fee-sheet	10957-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd
application-body	10957-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd 10957us0001.tif 10957us0002.tif 10957us0003.tif 10957us0004.tif 10957us0005.tif 10957us0006.tif
us-declaration	10957declaration1.tif
us-declaration	10957declaration2.tif
Comments	
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However, in the event that the payment through credit card is unsuccessful, the Commissioner is authorized to charge the required fees in connection with this application to: Deposit Account No. 50-2620 (Order No. 10957-US-PA), Deposit Account Name: Jianq Chyun Intellectual Property Office, Authorized User Name: Belinda Lee, E-mail: belinda@jcipgroup.com.tw; usa@jcipgroup.com.tw